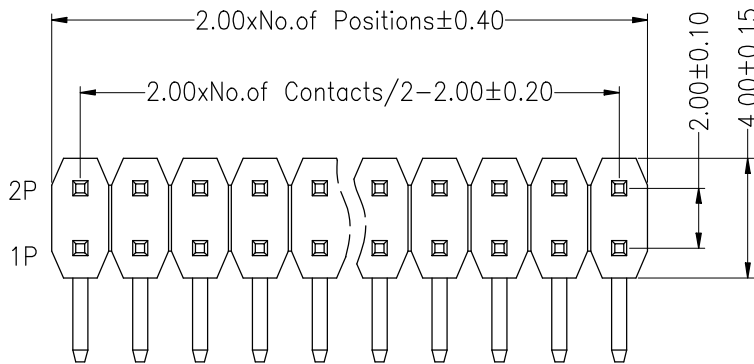




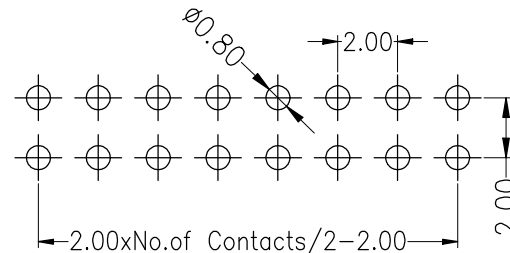
**SPECIFICATIONS**

Rated Current:2.0AMP  
 Contact Resistance:20mΩ Max  
 Withstand Voltage:500V AC  
 Insulation Resistance:1000MΩ Min  
 Operation Temperature:-40°c to +105°c

Contact Material:Brass  
 Contact Plating:Au or Sn Over Ni  
 Insulator Material:Polyester(UL94V-0)  
 Standard: PA6T  
 Soldering temperature:260°C±5° 5S



Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)



**Ordering Information**

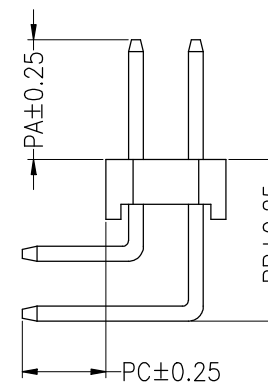
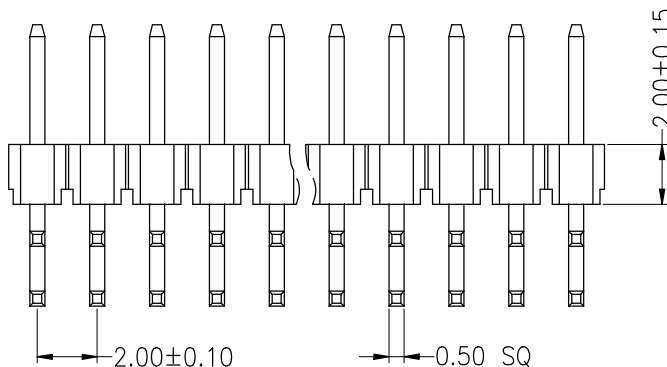
1320 12 XX X N XX R XXX X XX

No.of Pins Per Row 02~40P  
 Insulator Material Option  
 A=BK-PBT  
 C=BK-PA6T  
 E=BK-PA9T  
 F=BK-LCP

Contact Plating  
 G0:Gold Flash  
 G1:1u" Gold  
 G2:1.5u" Gold  
 G3:2u" Gold  
 G4:3u" Gold  
 G5:5u" Gold  
 G6:10u" Gold  
 G7:15u" Gold  
 G8:30u" Gold  
 S0:Gold Flash/Tin  
 SN:Tin

Pin Length  
 Packing  
 0=PE Bag  
 A=Tray

code stream  
 01~99



Dimension antitheses list

ITEM	PA	PB	PC
Standard	4.00	5.40	2.80

A0	2012.04.18	NEW DRAWING	CHANGE	OPERATION		DRAW	YiYuSheng	12.04.18	SCALE	FIT
				X.X	±0.30				UNIT	mm
				X.XX	±0.20	CHECK			SIZE	A4
				X.XXX	±0.10	APPROVE			SHEET	1/1
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL				PROJ.	☐

**JILN** 深圳锦凌电子股份有限公司  
 SHENZHEN JINLING ELECTRONICS CO.,LTD

Tel: 86-755-27483253 Fax: 86-755-2997-5588

PART NO.	132012XXXNXXRXXXXXX
TITLE:	2.0PH H2.0mm 2xNpin 90°